H. H. HARRIS FOUNDATION
SCHOLARSHIP APPLICATIONS

The H. H. Harris Foundation was created for the purpose of providing scholarships to students in the metallurgical and casting of metals field who are U.S. Citizens.

The average grant last year was in excess of $1,000 per student.

Application for scholarships with two letters of reference is **due as soon as possible and must be received no later than May 26, 2020.** You **must** use the current application included in this PDF. Old forms will not be accepted. Applications will **ONLY** be accepted by **ELECTRONIC EMAIL SUBMISSION** TO **CMICHOD@KOMDR.COM.** Do NOT Mail Applications.
H. H. Harris Scholarship Applications

In order to facilitate the compiling of applications, the applicants are advised of the following:

1. The two required reference letters should start as follows:
   “I am seconding John Doe, who is attending (will be attending) XYZ University.”

2. All applications should be signed. We will not accept any unsigned applications or those that do not have two (2) reference letters.

3. All parts of the application form are important for the Foundation Members’ consideration and should be completed with care. Make all submissions readable.

4. Applications will **ONLY** be accepted by **ELECTRONIC EMAIL SUBMISSION** TO **CMICHOD@KOMDR.COM**. Do NOT MAIL.

5. The **deadline** for the 2020 applications is May 26, 2020.

Sincerely yours,

H.H. HARRIS FOUNDATION

By: Charles L. Michod, Jr., Trustee

CLM,JR:
Encl.
The H.H. Harris Foundation was established pursuant to the terms of the Last Will of Henry Hickman Harris for the purpose of providing scholarships and other forms of educational aid to students and professionals in the metallurgical and casting of metals field who are U.S. citizens.

The Foundation members meet annually to make awards during June.

Applicants for scholarships should be submitted on this form along with two letters of reference to:

cmichod@komdr.com
H.H. Harris Foundation
Attn: Charles L. Michod, Jr., Trustee

**ELECTRONIC EMAIL SUBMISSION ONLY – DO NOT MAIL**

The deadline for 2020 is May 26, 2020.
H.H. Harris Foundation Scholarship Application (2020-2021)

Instructions: you can fill out this form electronically (preferred), or you may print the application and fill it in by hand in readable form. Applications will ONLY be accepted by ELECTRONIC EMAIL SUBMISSION TO CMICHOD@KOMDR.COM. Do NOT mail applications.

Please email the completed file to: cmichod@komdr.com.

1. Personal Information

Name: ________________________________

Address: ____________________________________________________________

City: ___________________ State: _______ Zip: ________________

Phone Number: ___________________ Email: ______________________

Age: _________ Marital Status: ○ Single ○ Married

Are you a U.S. Citizen? ○ Yes ○ No  (You must be a US Citizen to qualify.)

If awarded a scholarship, you will be required to provide your social security number.

2. Educational Background

High School: ________________________________

Location: ______________________________________

Date of graduation: _______________ Grade

point average: _______________ out of possible ____________

Undergraduate School: ________________________________

Location: ______________________________________

Major: ______________________________________

School class as of Fall 2020 will be: ○ Freshman ○ Sophomore ○ Junior ○ Senior

School you expect to attend this coming year: ________________________________

Grade point average: _______________ out of possible ____________

Date you expect to graduate/Date graduated: ________________________________

Graduate School (if applicable): ________________________________

Location: ______________________________________

Concentration: ______________________________________

Grade point average: _______________ out of possible ____________

Date you expect to graduate: ________________________________
3. Financial

Number of dependents you support, including yourself: ________________

How many children, including you, do your parents presently have in schools where tuition and/or room and board has been paid? ________________

Expenses you anticipate for the next school year: ________________

- What portion of that will be paid by your parents? ________________
- What portion of that will be paid by your own employment? ________________
- What portion of that will be paid with spousal income? ________________
- Other financial aid and/or scholarships already granted for this coming school year (please include the amount, date and name of organization that granted you the funds):

____________________________________________________________________
____________________________________________________________________
____________________________________________________________________
____________________________________________________________________

Amount you request from the H.H. Harris Foundation for the forthcoming school year? ________________

4. Employment/Internship Experience

Employer/Intern Location and dates for the last 3 years:

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<th>Company</th>
<th>Dates: From ___________ To ___________</th>
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<tr>
<td>Company</td>
<td>Dates: From ___________ To ___________</td>
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<tr>
<td>Company</td>
<td>Dates: From ___________ To ___________</td>
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Please explain your experience, including extracurricular and association activities, in metallurgy and/or metalcasting fields or related industries. You are encouraged to limit your response to the space provided, but may continue on a separate page if necessary.

5. Statement of Purpose
Please summarize your career plans and goals with regard to metalcasting and/or metallurgy. You are encouraged to limit your response to the space provided, but may continue on a separate page if necessary.
6. References

Attached or have mailed separately two original letters of reference from individuals familiar with your experience and capabilities in metallurgy and/or metalcasting.

Date: ______________________________

Applicant Signature: ____________________________________________

UNSIGNED APPLICATIONS WILL NOT BE CONSIDERED

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